TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (High-Speed U-MOS III)

TPC8016-H

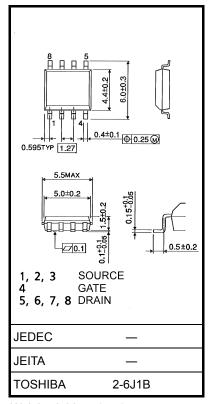
High-Efficiency DC / DC Converter Applications
Notebook PC Applications
Portable-Equipment Applications

- Small footprint due to small and thin package
- High-speed switching
- Small gate charge: Qg = 48 nc (typ.)
- Low drain-source ON-resistance: RDS (ON) = 3.7 m Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 25 \text{ S (typ.)}$
- Low leakage current: $I_{DSS} = 10 \mu A (max) (V_{DS} = 30 V)$
- Enhancement mode: $V_{th} = 1.1 \text{ to } 2.3 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA)}$

Absolute Maximum Ratings (Ta = 25°C)

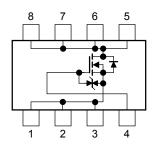
Characte	eristic	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	30	V
Drain-gate voltage (R	$R_{GS} = 20 \text{ k}\Omega$	V_{DGR}	30	V
Gate-source voltage		V_{GSS}	±20	V
Drain current	DC (Note 1)	ΙD	15	А
Drain current	Pulsed (Note 1)	I_{DP}	60	^
Drain power dissipati	on (t = 10 s) (Note 2a)	P_{D}	1.9	W
Drain power dissipati	on (t = 10 s) (Note 2b)	P _D	1.0	W
Single-pulse avalance	he energy (Note 3)	E _{AS}	146	mJ
Avalanche current		I _{AR}	15	Α
Repetitive avalanche	energy Note 2a) (Note 4)	E _{AR}	0.19	mJ
Channel temperature		T _{ch}	150	°C
Storage temperature	range	T _{stg}	-55 to 150	°C

Unit: mm



Weight: 0.085 g (typ.)

Circuit Configuration



Note: For Notes 1 to 4, refer to the next page.

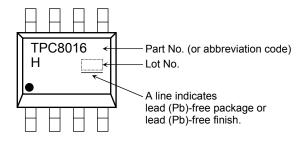
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Handle with care.

Thermal Characteristics

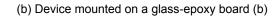
Characteristic	Symbol	Max	Unit	
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R _{th (ch-a)}	65.8	°C/W	
Thermal resistance, channel to ambient $(t = 10 \text{ s})$ (Note 2b)	R _{th (ch-a)}	125	°C/W	

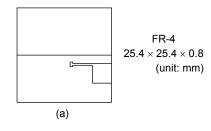
Marking (Note 5)

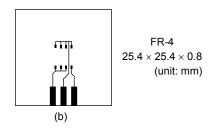


Note 1: The channel temperature should not exceed 150°C during use.

Note 2: (a) Device mounted on a glass-epoxy board (a)





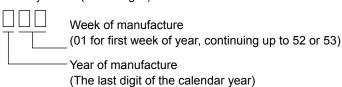


Note 3: V_{DD} = 24 V, T_{ch} = 25°C (initial), L = 0.5 mH, R_G = 25 Ω , I_{AR} = 15 A

Note 4: Repetitive rating: pulse width limited by max channel temperature

Note 5: • on the lower left of the marking indicates Pin 1.

* Weekly code: (Three digits)



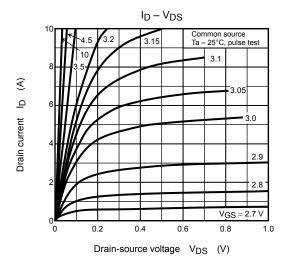
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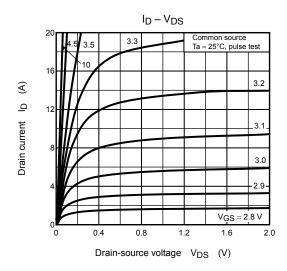
Electrical Characteristics (Ta = 25°C)

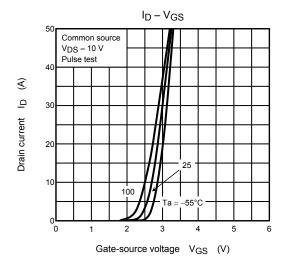
Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cui	rent	I _{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА
Drain cutoff curre	ent	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	_	_	10	μА
Drain-source breakdown voltage		V (BR) DSS	$I_D = 10$ mA, $V_{GS} = 0$ V	30	_	_	V
Diam-source bre	akdown voltage	V _{(BR) DSX}	$I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$	15	_	_	v
Gate threshold ve	oltage	V _{th}	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$	1.1	_	2.3	٧
Drain source ON	rosistanco	Pro (OV)	$V_{GS} = 4.5 \text{ V}, I_D = 7.5 \text{ A}$	_	5.5	7.5	mO
Drain-source ON-resistance		R _{DS} (ON)	V _{GS} = 10 V, I _D = 7.5 A	_	3.7	5.7	mΩ
Forward transfer admittance		Y _{fs}	V _{DS} = 10 V, I _D = 7.5 A	12.5	25	_	S
Input capacitance	nput capacitance C _{iss}			_	2380	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	410	_	pF
Output capacitance		Coss		_	980	_	
Switching time	Rise time	t _r	V _{GS} 10 V I _D = 7.5 A C C C C C C C C C	_	9.8	_	ns
	Turn-on time	t _{on}		_	21	_	
	Fall time	t _f		_	15	_	
	Turn-off time	t _{off}	$V_{DD} \simeq 15 \text{ V}$ Duty \leq 1%, $t_W = 10 \mu\text{s}$	_	60	_	
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \simeq 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$		46	_	
			$V_{DD} \simeq 24 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 15 \text{ A}$		26	_	
Gate-source charge 1		Q _{gs1}			7.2	_	nC
Gate-drain ("Miller") charge		Q _{gd}	$V_{DD} \simeq 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$		12.2	_	
Gate switch charge		Q _{SW}		_	15.6	_	

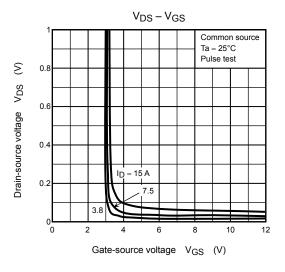
Source-Drain Ratings and Characteristics (Ta = 25°C)

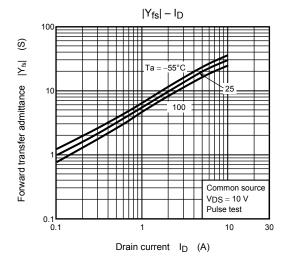
Character	istic		Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse	(Note 1)	I _{DRP}	_	_	_	60	Α
Forward voltage (diode)			V_{DSF}	I _{DR} = 15 A, V _{GS} = 0 V	_	_	-1.2	V

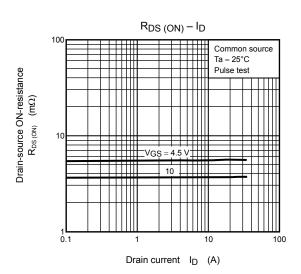


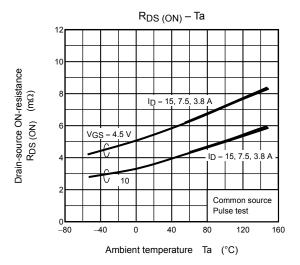


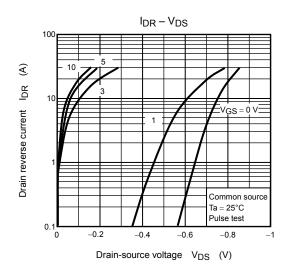


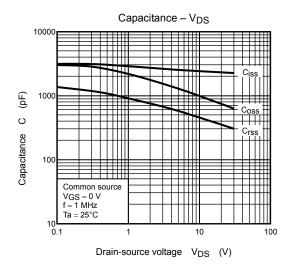


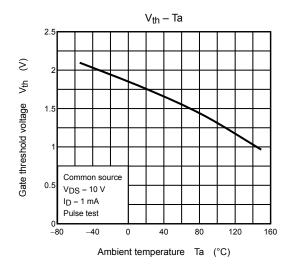


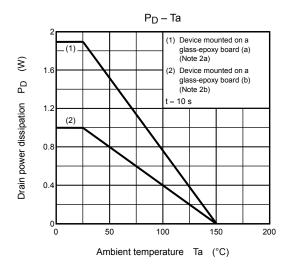


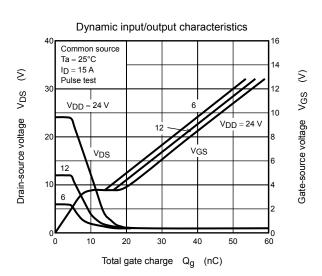




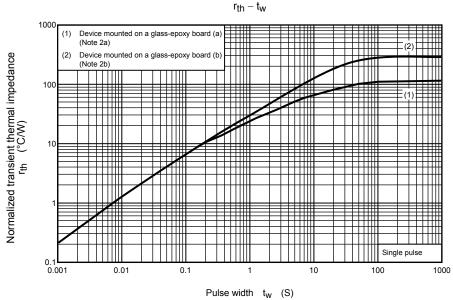




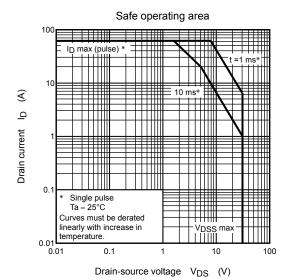




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